

BC184 Silicon NPN Small Signal Transistor

- BV_{CEO} = 30V (Min.)
- $h_{FE} = 130$ (Min.) @V_{CE} = 5.0V, I_C = 100mA



September 2007

1. Collector 2. Base 3. Emitter

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	30	V
V _{CBO}	Collector-Base Voltage	45	V
V _{EBO}	Emitter-Base Voltage	5	V
Ι _C	Collector Current (DC)	100	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range -55 ~ +150		°C

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics Ta=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
PD	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
R _{0JC}	Thermal Resistance, Junction to Case	125	°C/W
R _{0JA}	Thermal Resistance, Junction to Ambient	357	°C/W

*Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06".

Electrical Characteristics $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Voltage	I _C = 10μA	45			V
BV _{CEO}	Collector-Emitter Voltage	$I_{\rm C} = 2mA$	30			V
BV _{EBO}	Emitter-Base Voltage	I _E = 10μA	5			V
I _{EBO}	Emitter Cut-off Current	$V_{EB} = 4V$			15	nA
I _{CBO}	Collector Cut-off Current	V _{CB} = 30V			15	nA
h _{FE}	DC Current Gain	$V_{CE} = 5V, I_{C} = 10\mu A$ $V_{CE} = 5V, I_{C} = 100m A$	100 130			
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_{C} = 10mA, I_{B} = 0.5mA$ $I_{C} = 100mA, I_{B} = 5mA$			0.25 0.6	V
V _{BE} (sat)	Base-Emitter Saturation Voltage	$I_{\rm C} = 100 {\rm mA}, I_{\rm B} = 5 {\rm mA}$			1.2	V
V _{BE} (on)	Base-Emitter On Voltage	$V_{CE} = 5V, I_C = 2mA$	0.55		0.7	V
C _{ob}	Output Capacitance	V _{CE} = 10V, f = 1MHz			5	pF
f _T	Current gain Bandwidth Product	$V_{CE} = 5V, I_{C} = 10mA, f = 100MHz$	150			MHz

Notes:

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These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
These ratings are based on a maximum junction temperature of 150degrees C.



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